

Product Change Notice – PCN_DIMM-MX257-2_R2D

Rev	Date/Signature	Changes
1	20.03.2017/We	First Revision

1 Product affected

Product affected	Rev.	Replacement	Rev.
DIMM-MX257-2-ET	R2C	DIMM-MX257-2-ET	R2D

2 Change 1 – NAND-Flash Device

2.1 Key Characteristics of the Change

The NAND-Flash device is changed.

2.2 Description of Change to the Customer

The NAND-Flash IC4 is changed to W29N02GVSIAA from Winbond, because the previous part is discontinued by the manufacturer.

2.3 Customer Impact of Change and Recommended Action

No actions necessary.